Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM5P16FE

High Speed Switching Applications Analog Switch Applications

• Small package

• Low on-resistance $: R_{on} = 8 \Omega \text{ (max) (@V_{GS} = -4 V)}$

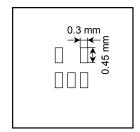
: $R_{on} = 12 \Omega \text{ (max) (@VGS} = -2.5 \text{ V)}$

: $R_{on} = 45 \Omega \text{ (max) } (@V_{GS} = -1.5 \text{ V})$

Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V _{DS}	-20	V	
Gate-Source voltage		V_{GSS}	±10	V	
Drain current	DC	I _D	-100	mA	
	Pulse	I _{DP}	-200		
Drain power dissipation (Ta = 25°C)		P _D (Note)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Total rating, mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 t, Cu Pad: 0.135 mm 2 \times 5)



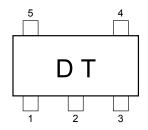
1.6±0.05 1.2±0.05 1.2±0.05 500+91 900+720 900+720 1. GATE 1 4. DRAIN 2 2. SOURCE 5. DRAIN 1 3. GATE 2

2-2P1B

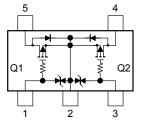
JEDEC

JEITA TOSHIBA

Marking



Equivalent Circuit (top view)



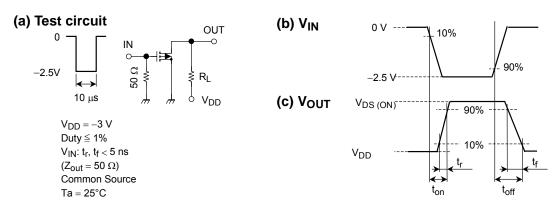
Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

Characteristic		Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0$	-20	_	_	V
Drain cut-off current		I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	_	_	-1	μΑ
Gate threshold voltage		V_{th}	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-0.6	_	-1.1	V
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -10 \text{ mA}$	25	_	_	mS
Drain-Source on-resistance		R _{DS (ON)}	$I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V}$	_	6	8	Ω
			$I_D = -10 \text{ mA}, V_{GS} = -2.5 \text{ V}$	_	8	12	
			$I_D = -1 \text{ mA}, V_{GS} = -1.5 \text{ V}$	_	18	45	
Input capacitance		C _{iss}		_	11	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = -3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	3.7	_	pF
Output capacitance		Coss		_	10	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -3 \text{ V}, I_{D} = -10 \text{ mA},$	_	130	_	ns
	Turn-off time	t _{off}	$V_{GS} = 0 \sim -2.5 \text{ V}$	_	190	_	

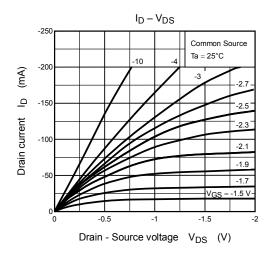
Switching Time Test Circuit

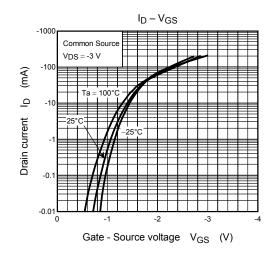


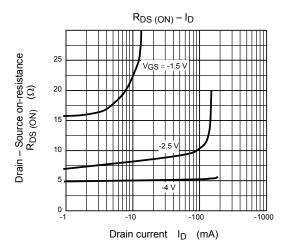
Precaution

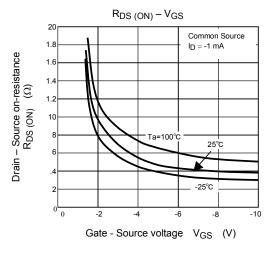
 V_{th} can be expressed as the voltage between the gate and source when the low operating current value is ID = $100~\mu A$ for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on).) Be sure to take this into consideration when using the device. The V_{GS} recommended voltage for turning on this product is -1.5V or higher.

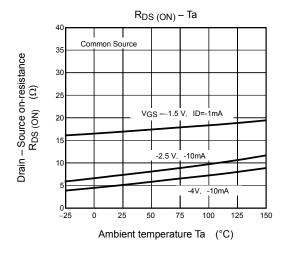
2

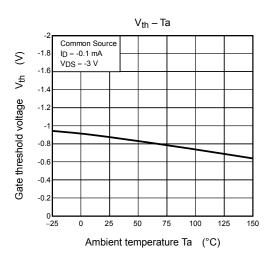




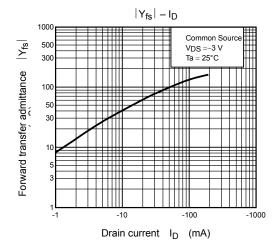


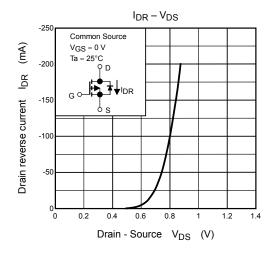


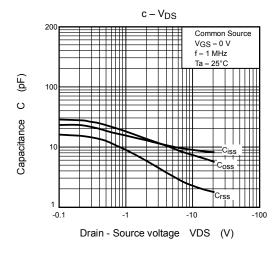


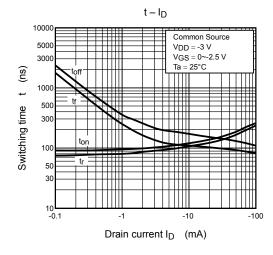


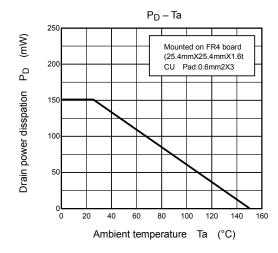
3 2004-08-17











4 2004-08-17

RESTRICTIONS ON PRODUCT USE

Handbook" etc..

030619EAA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No
 responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which
 may result from its use. No license is granted by implication or otherwise under any patent or patent rights of
 TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.